

Title (en)

CURRENTLESS SELECTIVE METALLIZATION OF STRUCTURED METAL SURFACES

Title (de)

STROMLOSE, SELEKTIVE METALLISIERUNG STRUKTURIERTER METALLOBERFLÄCHEN

Title (fr)

METALLISATION SELECTIVE SANS COURANT DE SURFACES METALLIQUES STRUCTUREES

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Application

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Abstract (en)

[origin: DE19718971A1] The invention relates to a method for selective metallization, or selective activation of metal substrates structured with plastic or oxide ceramic compounds. Only the metal surface is metallized, i.e. electro-conductively, without coating the structuring materials. The metal surface is metallized and activated in a single step.

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